



## MIC2582/MIC2583

### Single Channel Hot Swap Controllers

#### General Description

The MIC2582 and MIC2583 are single channel positive voltage hot swap controllers designed to allow the safe insertion of boards into live system backplanes. The MIC2582 and MIC2583 are available in 8-pin SOIC and 16-pin QSOP packages, respectively. Using a few external components and by controlling the gate drive of an external N-Channel MOSFET device, the MIC2582/83 provide inrush current limiting and output voltage slew rate control in harsh, critical power supply environments. Additionally, a circuit breaker function will latch the output MOSFET off if the current limit threshold is exceeded for a determined period. The MIC2583R option includes an auto-restart function upon detecting an over current condition.

Datasheets and support documentation can be found on Micrel's web site at [www.micrel.com](http://www.micrel.com).

#### Features

- MIC2582:
  - Pin-for-pin functional equivalent to the LTC1422
- 2.3V to 13.2V supply voltage operation
- Surge voltage protection up to 20V
- Current regulation limits inrush current regardless of load capacitance
- Programmable inrush current limiting
- Electronic circuit breaker
- Optional dual-level overcurrent threshold detects excessive load faults
- Fast response to short circuit conditions ( $<1\mu\text{s}$ )
- Programmable output under-voltage detection
- Under-voltage Lockout (UVLO) protection
- Auto-restart function (MIC2583R)
- Power-On Reset and Power-Good status outputs (Power-Good for the MIC2583 and MIC2583R only)
- /FAULT status output (MIC2583 and MIC2583R)

#### Applications

- RAID systems
- Base stations
- PC board hot swap insertion and removal
- +12V backplanes
- Network switches

#### Typical Applications

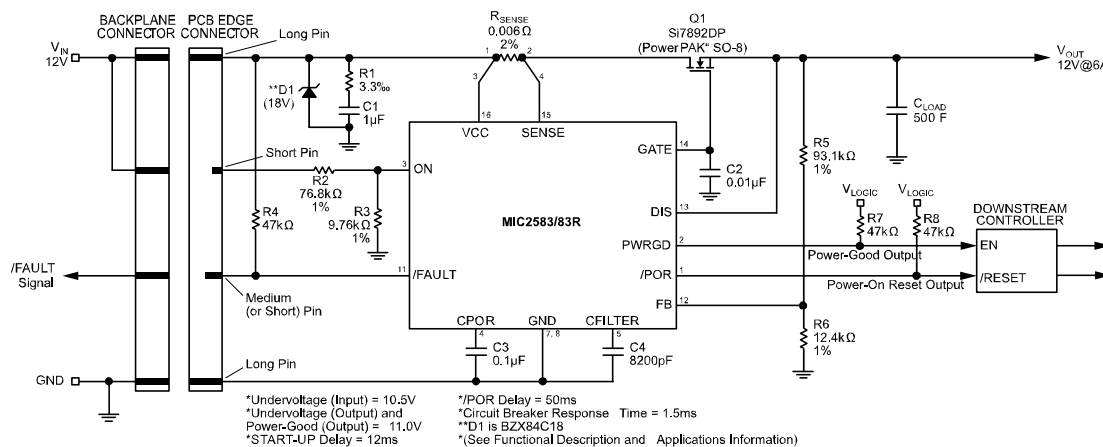


Figure 1. MIC2583/83R Typical Application Circuit

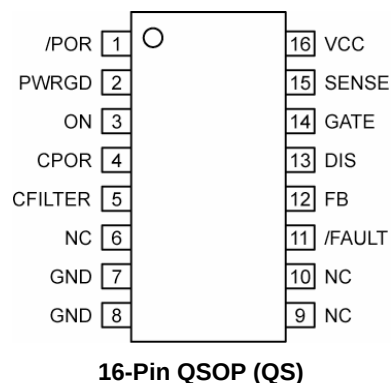
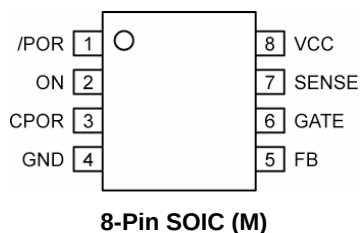
## Ordering Information

| Part Number   |               | Fast Circuit Breaker Threshold                                | Circuit Breaker | Package     |
|---------------|---------------|---------------------------------------------------------------|-----------------|-------------|
| Standard      | Pb-Free       |                                                               |                 |             |
| MIC2582-JBM   | MIC2582-xYM   | x = J, 100mV<br>x = J1, Off<br>x = M, Off                     | Latched off     | 8-Pin SOIC  |
| MIC2583-xBQS  | MIC2583-xYQS  | x = J, 100mV<br>x = K*, 150mV<br>x = L*, 200mV<br>x = M*, Off | Latched off     | 16-pin QSOP |
| MIC2583R-xBQS | MIC2583R-xYQS | x = J, 100mV<br>x = K*, 150mV<br>x = L*, 200mV<br>x = M*, Off | Auto-retry      | 16-pin QSOP |

**Note:**

\* Contact factory for availability.

## Pin Configuration



## Pin Description

| Pin Number<br>8-Pin SOIC | Pin Number<br>16-Pin QSOP | Pin Name | Pin Name                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
|--------------------------|---------------------------|----------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1                        | 1                         | /POR     | Power-On Reset Output: Open drain N-channel device, Active Low. This pin remains asserted during start-up until a time period ( $t_{POR}$ ) after the FB pin voltage rises above the power-good threshold ( $V_{FB}$ ). The timing capacitor $C_{POR}$ determines $t_{POR}$ . When the output voltage monitored at the FB pin falls below $V_{FB}$ , /POR is asserted for a minimum of one timing cycle ( $t_{POR}$ ). The /POR pin requires a pull-up resistor (10k $\Omega$ minimum) to VCC.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| 2                        | 3                         | ON       | ON Input: Active High. The ON pin, an input to a Schmitt-triggered comparator used to enable/disable the controller, is compared to a 1.24V reference with 50mV of hysteresis. When a logic high is applied to the ON pin ( $V_{ON} > 1.24V$ ), a start-up sequence begins when the GATE pin starts ramping up towards its final operating voltage. When the ON pin receives a logic low signal ( $V_{ON} < 1.19V$ ), the GATE pin is grounded and /FAULT remains high if VCC is above the UVLO threshold. ON must be low for 20 $\mu$ s in order to initiate a start-up sequence. Additionally, toggling the ON pin LOW to HIGH resets the circuit breaker.                                                                                                                                                                                                                                                                                                                      |
| 3                        | 4                         | CPOR     | Power-On Reset Timer: A capacitor connected between this pin and ground sets the supply contact start-up delay ( $t_{START}$ ) and the power-on reset interval ( $t_{POR}$ ). When VCC rises above the UVLO threshold, the capacitor connected to $C_{POR}$ begins to charge. When the voltage at CPOR crosses 0.3V, the start-up threshold ( $V_{START}$ ), a start cycle is initiated if ON is asserted while capacitor $C_{POR}$ is immediately discharged to ground. When the voltage at FB rises above $V_{FB}$ , capacitor $C_{POR}$ begins to charge again. When the voltage at CPOR rises above the power-on reset delay threshold ( $V_{TH}$ ), the timer resets by pulling CPOR to ground, and /POR is de-asserted. If $C_{POR}$ is left open, then $t_{START}$ defaults to 20 $\mu$ s.                                                                                                                                                                                 |
| 4                        | 7, 8                      | GND      | Ground Connection: Tie to analog ground.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                          |
| 5                        | 12                        | FB       | Power-Good Threshold Input (Under-voltage Detect): This input is internally compared to a 1.24V reference with 30mV of hysteresis. An external resistive divider may be used to set the voltage at this pin. If this input momentarily goes below 1.24V, then /POR is activated for one timing cycle, $t_{POR}$ , indicating an output under-voltage condition. The /POR signal de-asserts one timing cycle after the FB pin exceeds the power-good threshold by 30mV. A 5 $\mu$ s filter on this pin prevents glitches from inadvertently activating this signal.                                                                                                                                                                                                                                                                                                                                                                                                                |
| 6                        | 14                        | GATE     | Gate Drive Output: Connects to the gate of an external N-channel MOSFET. An internal clamp ensures that no more than 9V is applied between the GATE pin and the source of the external MOSFET. The GATE pin is immediately brought low when either the circuit breaker trips or an under-voltage lockout condition occurs.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| 7                        | 15                        | SENSE    | Circuit Breaker Sense Input: A resistor between this pin and VCC sets the current limit threshold. Whenever the voltage across the sense resistor exceeds the slow trip current limit threshold ( $V_{TRIPSLow}$ ), the GATE voltage is adjusted to ensure a constant load current. If $V_{TRIPSLow}$ (50mV) is exceeded for longer than time period $t_{OCSLOW}$ , then the circuit breaker is tripped and the GATE pin is immediately pulled low. If the voltage across the sense resistor exceeds the fast trip circuit breaker threshold, $V_{TRIPFAST}$ , at any point due to fast, high amplitude power supply faults, then the GATE pin is immediately brought low without delay. To disable the circuit breaker, the SENSE and VCC pins can be tied together. The default $V_{TRIPFAST}$ for either device is 100mV. Other fast trip thresholds are available: 150mV, 200mV, or OFF ( $V_{TRIPFAST}$ disabled). Please contact factory for availability of other options. |
| 8                        | 16                        | VCC      | Positive Supply Input: 2.3V to 13.2V. The GATE pin is held low by an internal under-voltage lockout circuit until VCC exceeds a threshold of 2.2V. If VCC exceeds 13.2V, an internal shunt regulator protects the chip from transient voltages up to 20V at the VCC and SENSE pins.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |

| Pin Number<br>8-Pin SOIC | Pin Number<br>16-Pin QSOP | Pin Name | Pin Name                                                                                                                                                                                                                                                                                              |
|--------------------------|---------------------------|----------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| n/a                      | 2                         | PWRGD    | Power-Good Output: Open drain N-channel device, Active High. When the voltage at the FB pin is lower than 1.24V, PWRGD output is held low. When the voltage at the FB pin exceeds 1.24V, then PWRGD is asserted immediately. The PWRGD pin requires a pull-up resistor (10k $\Omega$ minimum) to VCC. |
| n/a                      | 5                         | CFILTER  | Current Limit Response Timer: A capacitor connected to this pin defines the period of time ( $t_{OCSLOW}$ ) in which an over current event must last to signal a fault condition and trip the circuit breaker. If no capacitor is connected, then $t_{OCSLOW}$ defaults to 5 $\mu$ s.                 |
| n/a                      | 11                        | /FAULT   | Circuit Breaker Fault Status Output: Open drain N-channel device, Active Low. The /FAULT pin is asserted when the circuit breaker trips due to an over current condition or when an under-voltage lockout condition exists. The /FAULT pin requires a pull-up resistor (10k $\Omega$ minimum) to VCC. |
| n/a                      | 13                        | DIS      | Discharge Output: When the MIC2583/83R is turned off, a 500 $\Omega$ internal resistor at this output allows the discharging of any load capacitance to ground.                                                                                                                                       |
| n/a                      | 6, 9, 10                  | NC       | No internal connection.                                                                                                                                                                                                                                                                               |

**Absolute Maximum Ratings<sup>(1)</sup>**

|                                   |                        |
|-----------------------------------|------------------------|
| Supply Voltage ( $V_{CC}$ )       | –0.3V to 20V           |
| /POR, /FAULT, PWRGD pins          | –0.3V to 15V           |
| SENSE pin                         | –0.3V to $V_{CC}+0.3V$ |
| ON pin                            | –0.3V to $V_{CC}+0.3V$ |
| GATE pin                          | –0.3V to 20V           |
| FB Input pins                     | –0.3V to 6V            |
| Junction Temperature              | +125°C                 |
| Lead Temperature                  |                        |
| Standard Package (–JBM and –xBQS) |                        |
| (IR Reflow, Peak Temperature)     | ..240°C + 0°C/–5°C     |
| Pb-Free Package (–xYM or –xYQS)   |                        |
| (IR Reflow, Peak Temperature)     | ..260°C + 0°C/–5°C     |
| EDS Rating                        |                        |
| Human body model                  | ..2kV                  |
| Machine model                     | ..100V                 |

**Operating Ratings<sup>(2)</sup>**

|                               |                 |
|-------------------------------|-----------------|
| Supply Voltage ( $V_{CC}$ )   | +2.3V to +13.2V |
| Ambient Temperature ( $T_A$ ) | –40°C to +85°C  |
| Junction Thermal Resistance   |                 |
| SOIC ( $\theta_{JA}$ )        | ..163°C/W       |
| QSOP ( $\theta_{JA}$ )        | ..112°C/W       |

**Electrical Characteristics<sup>(3)</sup>**

$V_{CC} = 5.0V$ ,  $T_A = 25^\circ C$  unless noted. **Bold** values indicate  $-40^\circ C \leq T_A \leq +85^\circ C$ .

| Symbol               | Parameter                                                             | Condition                                                                  |                                                                | Min              | Typ               | Max               | Units          |
|----------------------|-----------------------------------------------------------------------|----------------------------------------------------------------------------|----------------------------------------------------------------|------------------|-------------------|-------------------|----------------|
| V <sub>CC</sub>      | Supply Voltage                                                        |                                                                            |                                                                | 2.3              |                   | 13.2              | V              |
| I <sub>CC</sub>      | Supply Current                                                        | V <sub>ON</sub> = 2V                                                       |                                                                |                  | 1.5               | 2.5               | mA             |
| V <sub>TRIP</sub>    | Circuit Breaker Trip Voltage<br>(Current Limit Threshold)             | V <sub>TRIP</sub> = V <sub>CC</sub> – V <sub>SENSE</sub>                   | V <sub>TRIPSLOW</sub>                                          | 42               | 50                | 59                |                |
|                      |                                                                       |                                                                            | V <sub>TRIPFAST</sub><br>(MIC2582-Jxx)                         |                  | 100               |                   | mV             |
|                      |                                                                       |                                                                            | V <sub>TRIPFAST</sub><br>(MIC2583/83R) X = J<br>X = K<br>X = L | 85<br>130<br>175 | 100<br>150<br>200 | 110<br>170<br>225 | mV<br>mV<br>mV |
| V <sub>GS</sub>      | External Gate Drive                                                   | V <sub>GATE</sub> – V <sub>CC</sub>                                        | V <sub>CC</sub> > 3V                                           | 7                | 8                 | 9                 | V              |
|                      |                                                                       |                                                                            | V <sub>CC</sub> = 2.3V                                         | 3.5              | 4.8               | 6.5               | V              |
| I <sub>GATE</sub>    | GATE Pin Pull-Up Current                                              | Start Cycle, V <sub>GATE</sub> = 0V, V <sub>CC</sub> = 13.2V               |                                                                | –30              | 17                | –8                | μA             |
|                      |                                                                       | V <sub>CC</sub> = 2.3V                                                     |                                                                | –26              | 17                | –8                | μA             |
| I <sub>GATEOFF</sub> | GATE Pink Sink Current                                                | V <sub>GATE</sub> > 1V                                                     | V <sub>CC</sub> = 13.2V, Note 4                                |                  | 100               |                   | μA             |
|                      |                                                                       |                                                                            | V <sub>CC</sub> = 2.3V, Note 4                                 |                  | 50                |                   | μA             |
|                      |                                                                       | /FAULT = 0<br>(MIC2583/83R only)                                           | Turn Off                                                       |                  | 110               |                   | μA             |
| I <sub>TIMER</sub>   | Current Limit/Overcurrent Timer<br>(CFILTER) Current<br>(MIC2583/83R) | V <sub>CC</sub> – V <sub>SENSE</sub> > V <sub>TRIPSLOW</sub> (timer on)    |                                                                | –8.5             | –6.5              | –4.5              | μA             |
|                      |                                                                       | V <sub>CC</sub> – V <sub>SENSE</sub> > V <sub>TRIPSLOW</sub> (timer off)   |                                                                | 4.5              | 6.5               | 8.5               | μA             |
| I <sub>CPOR</sub>    | Power-On-Reset Timer Current                                          | Timer on                                                                   |                                                                | –3.5             | 2.5               | –1.5              | μA             |
|                      |                                                                       | Timer off                                                                  |                                                                | 0.5              | 1.3               |                   | mA             |
| V <sub>TH</sub>      | POR Delay and Overcurrent<br>Timer (CFILTER) Threshold                | V <sub>CPOR</sub> rising<br>V <sub>CFILTER</sub> rising (MIC2583/83R only) |                                                                | 1.19             | 1.245             | 1.30              | V              |
| V <sub>UV</sub>      | Undervoltage Lockout Threshold                                        | V <sub>CC</sub> rising                                                     |                                                                | 2.1              | 2.2               | 2.3               | V              |
|                      |                                                                       | V <sub>CC</sub> falling                                                    |                                                                | 1.90             | 2.05              | 2.20              | V              |
| V <sub>UVHYS</sub>   | Undervoltage Lockout Hysteresis                                       |                                                                            |                                                                |                  | 150               |                   | mV             |
| V <sub>ON</sub>      | ON Pin Threshold Voltage                                              | 2.3V ≤ V <sub>CC</sub> ≤ 13.2V                                             | ON rising                                                      | 1.19             | 1.24              | 1.29              | V              |
|                      |                                                                       |                                                                            | ON falling                                                     | 1.14             | 1.19              | 1.24              | V              |
| V <sub>ONHYS</sub>   | ON Pin Hysteresis                                                     |                                                                            |                                                                |                  | 50                |                   | mV             |

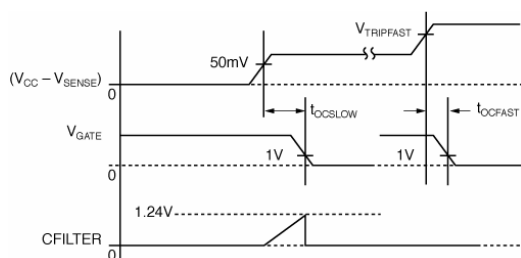
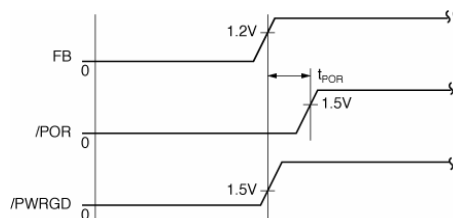
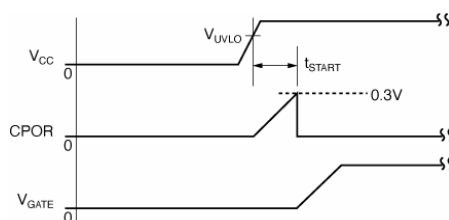
| Symbol          | Parameter                                                           | Condition                              | Min         | Typ  | Max         | Units    |
|-----------------|---------------------------------------------------------------------|----------------------------------------|-------------|------|-------------|----------|
| $\Delta V_{ON}$ | ON Pin Threshold Line Regulation                                    | $2.3V \leq V_{CC} \leq 13.2V$          |             | 2    |             | mV       |
| $I_{ON}$        | ON Pin Input Current                                                | $V_{ON} = V_{CC}$                      |             |      | -0.5        | $\mu A$  |
| $V_{START}$     | Start-Up Delay Timer Threshold                                      | $V_{CPOR}$ rising                      | <b>0.26</b> | 0.31 | <b>0.36</b> | V        |
| $V_{AUTO}$      | Auto-Restart Threshold Voltage (MIC2583R only)                      | Upper threshold                        | <b>0.19</b> | 1.24 | <b>1.30</b> | V        |
|                 |                                                                     | Lower threshold                        | <b>0.26</b> | 0.31 | <b>0.36</b> | V        |
| $I_{AUTO}$      | Auto-Restart Current (MIC2583R only)                                | Charge current                         | <b>10</b>   | 13   | <b>16</b>   | $\mu A$  |
|                 |                                                                     | Discharge current                      |             | 1.4  | <b>2</b>    | $\mu A$  |
| $V_{FB}$        | Power-Good Threshold Voltage                                        | $2.3V = V_{CC} = 13.2V$ FB rising      | <b>1.19</b> | 1.24 | <b>1.29</b> | V        |
|                 |                                                                     | FB falling                             | <b>1.15</b> | 1.20 | <b>1.25</b> | V        |
| $V_{FBHYS}$     | FB Hysteresis                                                       |                                        |             | 40   |             | mV       |
| $I_{FBLKG}$     | FB Pin Leakage Current                                              | $2.3V = V_{CC} = 13.2V, V_{FB} = 1.3V$ |             |      | <b>1.5</b>  | $\mu A$  |
| $V_{OL}$        | /POR, /FAULT, PWRGD Output Voltage (/FAULT, PWRGD MIC2583/83R only) | $I_{OUT} = 1mA$                        |             |      | <b>0.4</b>  | V        |
| $R_{DIS}$       | Output Discharge Resistance (MIC2583/83R only)                      |                                        |             | 500  | <b>1000</b> | $\Omega$ |

**AC Parameters<sup>(4)</sup>**

|              |                                              |                                                                           |  |    |  |         |
|--------------|----------------------------------------------|---------------------------------------------------------------------------|--|----|--|---------|
| $t_{OCFAST}$ | Fast Overcurrent SENSE to GATE Low Trip Time | $V_{CC} = 5V, V_{CC} - V_{SENSE} = 100mV$<br>$C_{GATE} = 10nF$ , Figure 2 |  | 1  |  | $\mu s$ |
| $t_{OCSLOW}$ | Slow Overcurrent SENSE to GATE Low Trip Time | $V_{CC} = 5V, V_{CC} - V_{SENSE} = 50mV$<br>$C_{FILTER} = 0$ , Figure 2   |  | 5  |  | $\mu s$ |
| $t_{ONDLY}$  | ON Delay Filter                              |                                                                           |  | 20 |  | $\mu s$ |
| $t_{FBDLY}$  | FB Delay Filter                              |                                                                           |  | 20 |  | $\mu s$ |

**Notes:**

1. Exceeding the absolute maximum rating may damage the device.
2. The device is not guaranteed to function outside its operating rating.
3. Specification for packaged product only.
4. Not a tested parameter, guaranteed by design.

**Timing Diagrams****Figure 2. Current-Limit Response****Figure 3. Power-On Reset Response****Figure 4. Power-On Start-Up Delay Timing**

## Test Circuit

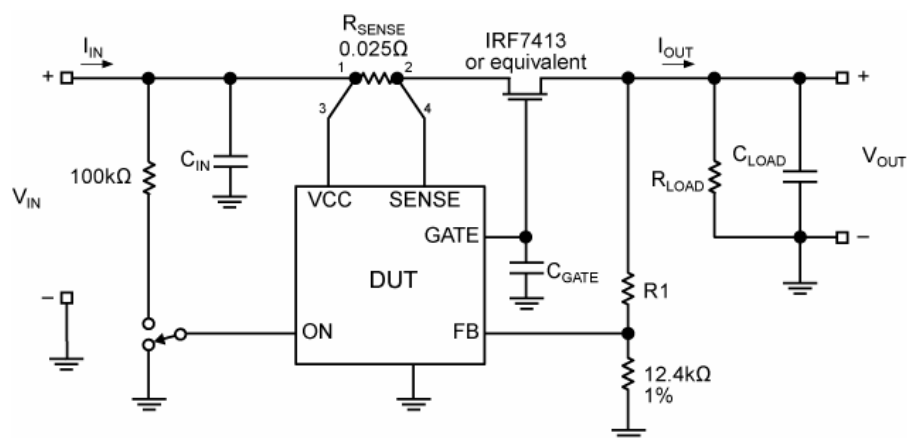
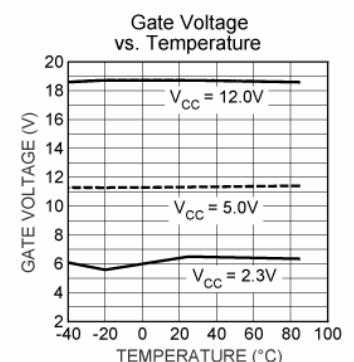
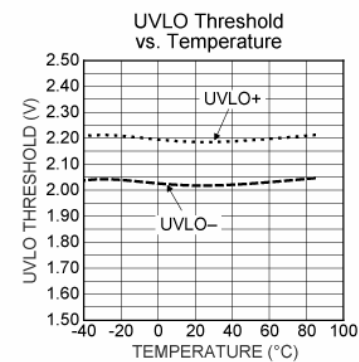
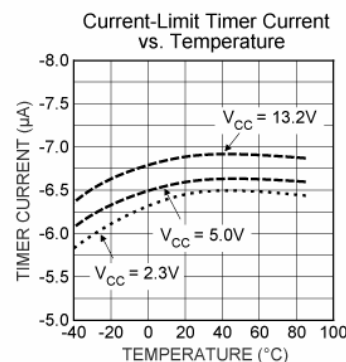
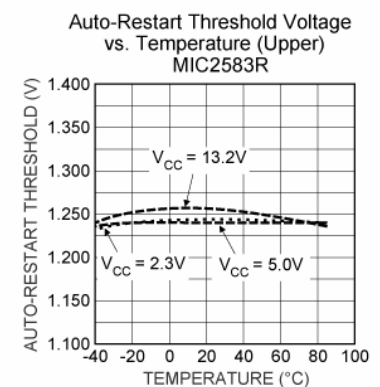
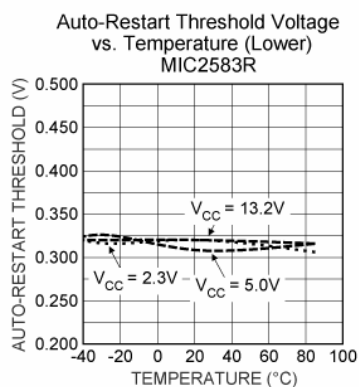
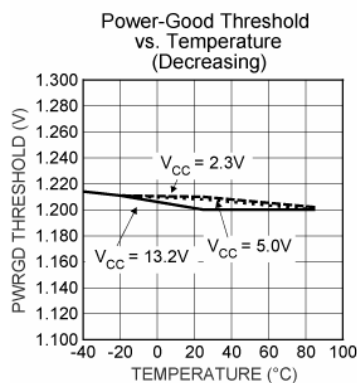
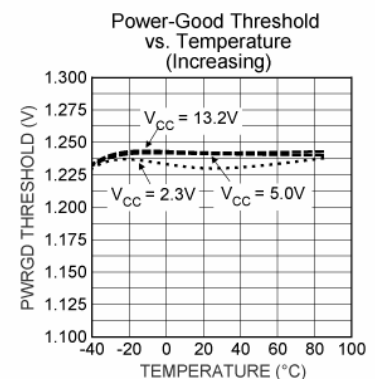
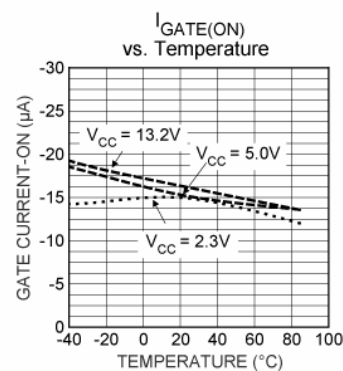
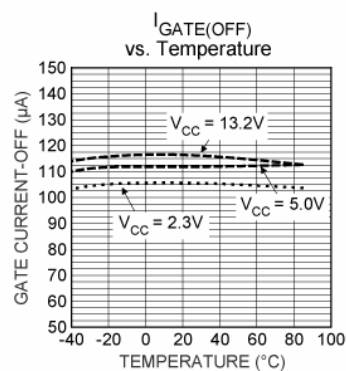
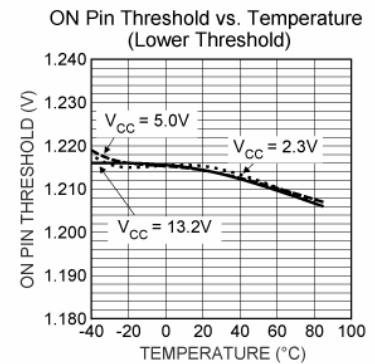
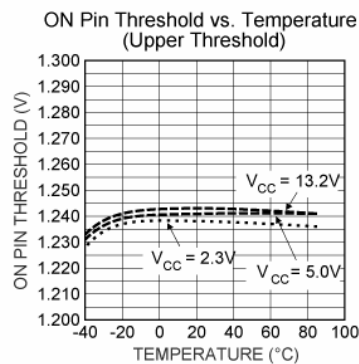
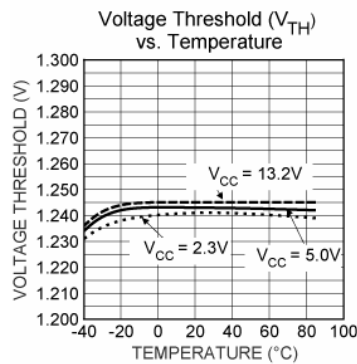
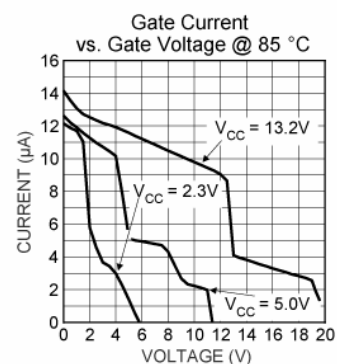
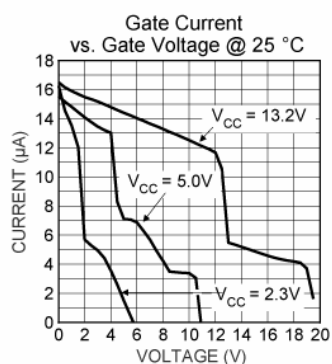
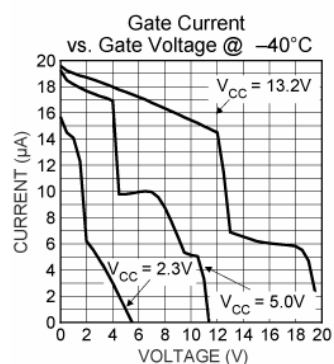
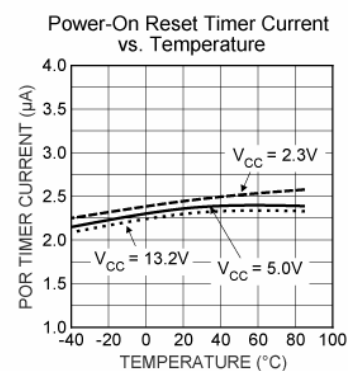
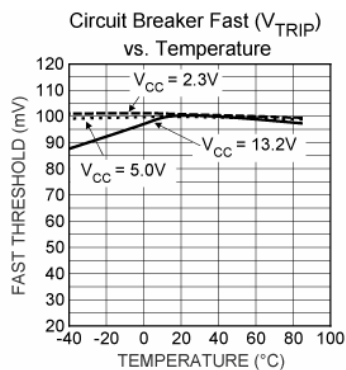
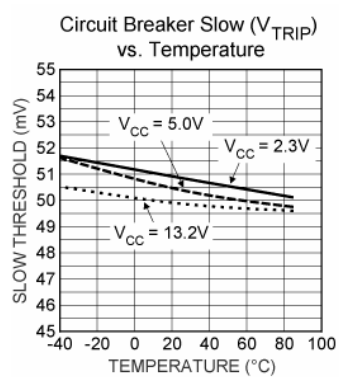


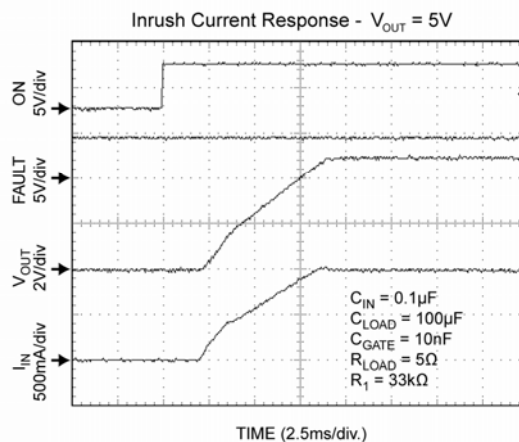
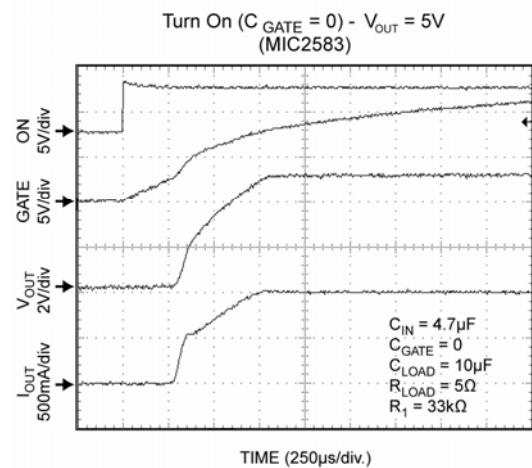
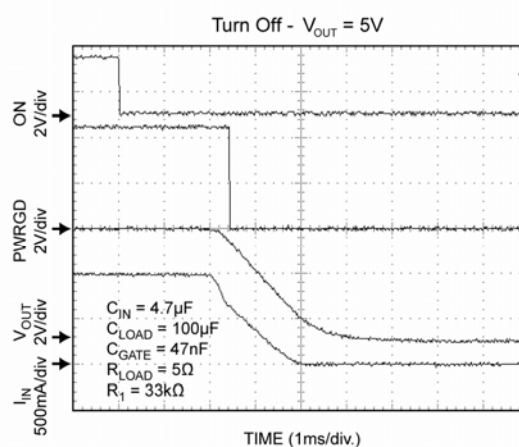
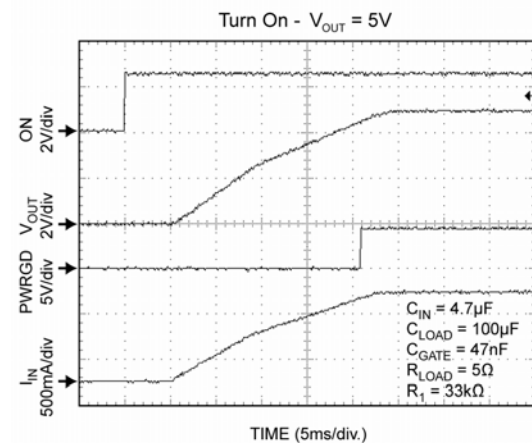
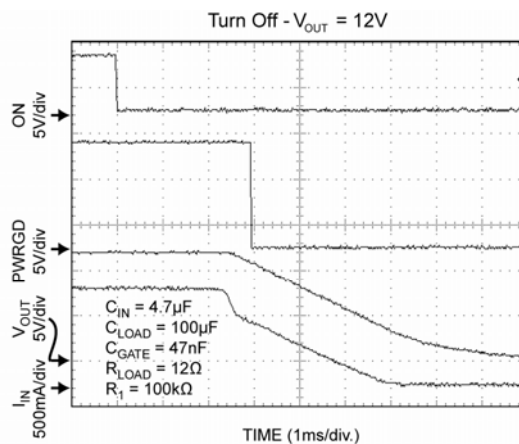
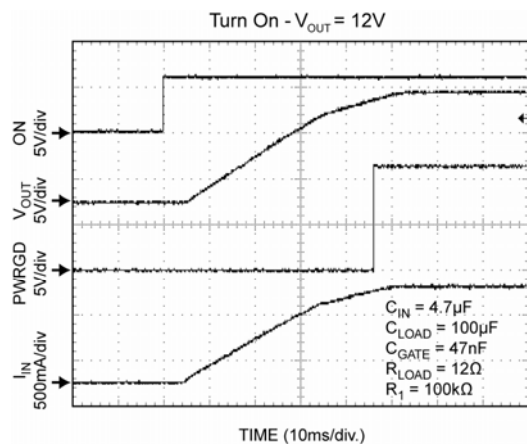
Figure 5. Applications Test Circuit  
(not all pins shown for simplicity)

## Typical Characteristics

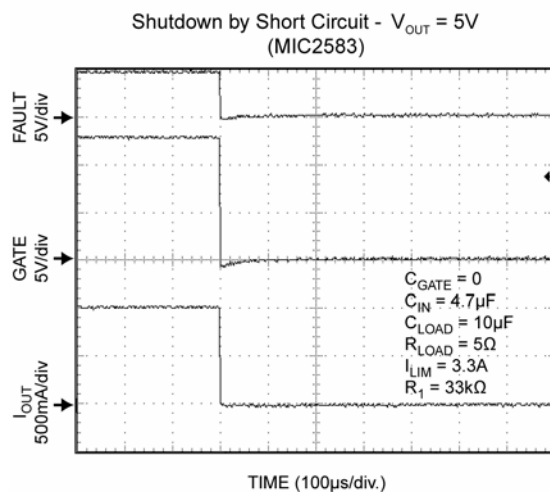
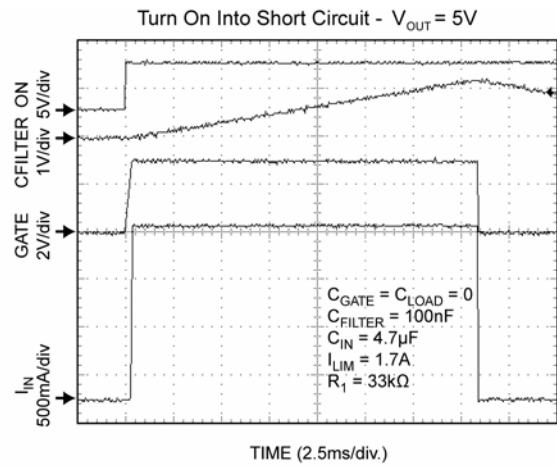
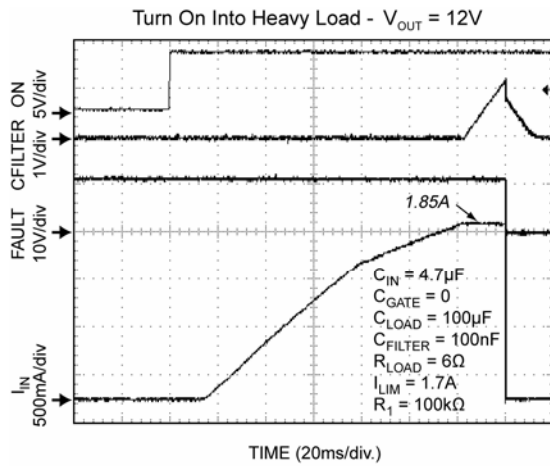




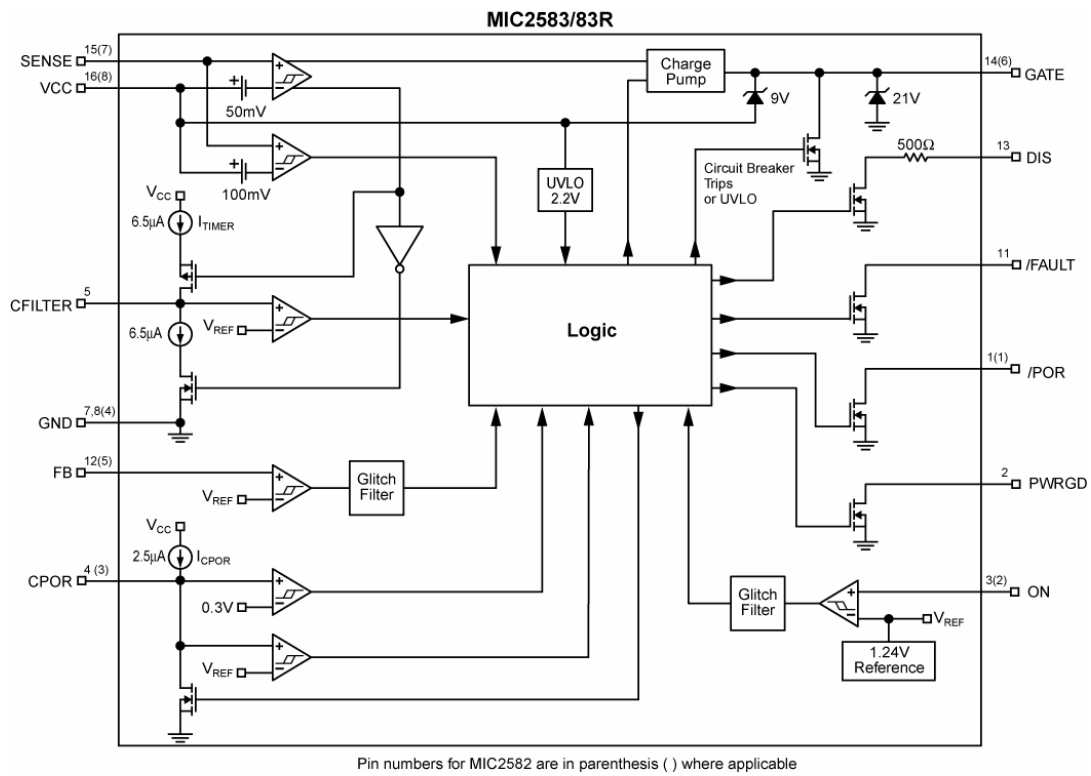
## Functional Characteristics (See Figure 5, Applications Test Circuit)



## Functional Characteristics (See Figure 5, Applications Test Circuit)



## Functional Diagram



## Functional Description

### Hot Swap Insertion

When circuit boards are inserted into live system backplanes and supply voltages, high inrush currents can result due to the charging of bulk capacitance that resides across the supply pins of the circuit board. This inrush current, although transient in nature, may be high enough to cause permanent damage to on board components or may cause the system's supply voltages to go out of regulation during the transient period which may result in system failures. The MIC2582 and MIC2583 act as a controller for external N-Channel MOSFET devices in which the gate drive is controlled to provide inrush current limiting and output voltage slew rate control during hot plug insertions.

### Power Supply

VCC is the supply input to the MIC2582/83 controller with a voltage range of 2.3V to 13.2V. The VCC input can withstand transient spikes up to 20V. In order to ensure stability of the supply voltage, a minimum 0.47μF capacitor from VCC to ground is recommended. Alternatively, a low pass filter, shown in the typical application circuit (see Figure 1), can be used to eliminate high frequency oscillations as well as help suppress transient spikes.

Also, due to the existence of an undetermined amount of parasitic inductance in the absence of bulk capacitance along the supply path, placing a Zener diode at the VCC of the controller to ground in order to provide external supply transient protection is strongly recommended for relatively high current applications ( $\geq 3A$ ). See Figure 1.

### Start-Up Cycle

#### Supply Contact Delay

During a hot insert of a PC board into a backplane or when the supply (VCC) is powered up, as the voltage at the ON pin rises above its threshold (1.24V typical), the MIC2582/83 first checks that both supply voltages are above their respective UVLO thresholds. If so, the device is enabled and an internal 2.5μA current source begins charging capacitor C<sub>POR</sub> to 0.3V to initiate a start-up sequence. Once the start-up delay (t<sub>START</sub>) elapses, the CPOR pin is pulled immediately to ground and a 17μA current source begins charging the GATE output to drive the external MOSFET that switches V<sub>IN</sub> to V<sub>OUT</sub>. The programmed contact start-up delay is calculated using the following equation:

$$t_{START} = C_{POR} \left[ \frac{V_{START}}{I_{CPOR}} \right] \cong 0.12 \times C_{POR} (\mu F) \quad (1)$$

Where the start-up delay timer threshold (V<sub>START</sub>) is 0.3V, and the Power-On Reset timer current (I<sub>CPOR</sub>) is 2.5μA. See Table 2 for some typical supply contact start-up

delays using several standard value capacitors. As the GATE voltage continues ramping toward its final value (V<sub>CC</sub> + V<sub>GS</sub>) at a defined slew rate (See Load Capacitance/Gate Capacitance Dominated Startup sections), a second CPOR timing cycle begins if: 1)/FAULT is high and 2)CFILTER is low (i.e., not an overvoltage, undervoltage lockout, or overcurrent state). This second timing cycle (t<sub>POR</sub>) begins when the voltage at the FB pin exceeds its threshold (V<sub>FB</sub>). This condition indicates that the output voltage is valid. See Figure 3 in the Timing Diagrams. When the power supply is already present (i.e., not a "hot swapping" condition) and the MIC2582/83 device is enabled by applying a logic high signal at the ON pin, the GATE output begins ramping immediately as the first CPOR timing cycle is bypassed. Active current regulation is employed to limit the inrush current transient response during start-up by regulating the load current at the programmed current limit value (See Current Limiting and Dual-Level Circuit Breaker section). The following equation is used to determine the nominal current limit value:

$$I_{LIM} = \frac{V_{TRIPSLow}}{R_{SENSE}} = \frac{50mV}{R_{SENSE}} \quad (2)$$

where V<sub>TRIPSLow</sub> is the current limit slow trip threshold found in the electrical table and R<sub>SENSE</sub> is the selected value that will set the desired current limit. There are two basic start-up modes for the MIC2582/83: 1) Start-up dominated by load capacitance and 2) start-up dominated by total gate capacitance. The magnitude of the inrush current delivered to the load will determine the dominant mode. If the inrush current is greater than the programmed current limit (I<sub>LIM</sub>), then load capacitance is dominant. Otherwise, gate capacitance is dominant. The expected inrush current may be calculated using the following equation:

$$INRUSH \cong I_{GATE} \times \frac{C_{LOAD}}{C_{GATE}} = 17\mu A \times \frac{C_{LOAD}}{C_{GATE}} \quad (3)$$

where I<sub>GATE</sub> is the GATE pin pull-up current, C<sub>LOAD</sub> is the load capacitance, and C<sub>GATE</sub> is the total GATE capacitance (C<sub>ISS</sub> of the external MOSFET and any external capacitor connected from the MIC2582/83 GATE pin to ground).

#### Load Capacitance Dominated Start-Up

In this case, the load capacitance (C<sub>LOAD</sub>) is large enough to cause the inrush current to exceed the programmed current limit but is less than the fast-trip threshold (or the fast-trip threshold is disabled, 'M' option). During start-up under this condition, the load current is regulated at the programmed current limit value (I<sub>LIM</sub>) and held constant until the output voltage rises to its final value. The output slew rate and equivalent GATE voltage slew rate is computed by the

following equation:

$$\text{Output Voltage Slew Rate, } dV_{\text{OUT}}/dt = \frac{I_{\text{LIM}}}{C_{\text{LOAD}}} \quad (4)$$

where  $I_{\text{LIM}}$  is the programmed current limit value. Consequently, the value of  $C_{\text{FILTER}}$  must be selected to ensure that the overcurrent response time,  $t_{\text{OCSLOW}}$ , exceeds the time needed for the output to reach its final value. For example, given a MOSFET with an input capacitance  $C_{\text{ISS}} = C_{\text{GATE}} = 4700\text{pF}$ ,  $C_{\text{LOAD}}$  is  $2200\mu\text{F}$ , and  $I_{\text{LIM}}$  is set to 6A with a 12V input, then the load capacitance dominates as determined by the calculated  $\text{INRUSH} > I_{\text{LIM}}$ . Therefore, the output voltage slew rate determined from Equation 4 is:

$$\text{Output Voltage Slew Rate, } dV_{\text{OUT}}/dt = \frac{6\text{A}}{2200\mu\text{F}} = 2.73 \frac{\text{V}}{\text{ms}}$$

and the resulting  $t_{\text{OCSLOW}}$  needed to achieve a 12V output is approximately 4.5ms. (See Power-On Reset and Overcurrent Timer Delays section to calculate  $t_{\text{OCSLOW}}$ ).

#### GATE Capacitance Dominated Start-Up

In this case, the value of the load capacitance relative to the GATE capacitance is small enough such that the load current during start-up never exceeds the current limit threshold as determined by Equation 3. The minimum value of  $C_{\text{GATE}}$  that will ensure that the current limit is never exceeded is given by the equation below:

$$C_{\text{GATE}}(\text{min}) = \frac{I_{\text{GATE}}}{I_{\text{LIM}}} \times C_{\text{LOAD}} \quad (5)$$

where  $C_{\text{GATE}}$  is the summation of the MOSFET input capacitance ( $C_{\text{ISS}}$ ) and the value of the external capacitor connected to the GATE pin of the MIC2582/83 to ground. Once  $C_{\text{GATE}}$  is determined, use the following equation to determine the output slew rate for gate capacitance dominated start-up.

$$dV_{\text{OUT}}/dt = \frac{I_{\text{GATE}}}{C_{\text{GATE}}} \quad (6)$$

Table 1 depicts the output slew rate for various values of  $C_{\text{GATE}}$ .

| $I_{\text{GATE}} = 17\mu\text{A}$ |                      |
|-----------------------------------|----------------------|
| $C_{\text{GATE}}$                 | $dV_{\text{OUT}}/dt$ |
| $0.001\mu\text{F}$                | 17V/ms               |
| $0.01\mu\text{F}$                 | 1.7V/ms              |
| $0.1\mu\text{F}$                  | 0.17V/ms             |
| $1\mu\text{F}$                    | 0.017V/ms            |

**Table 1. Output Slew Rate Selection for GATE Capacitance Dominated Start-Up**

#### Current Limiting and Dual-Level Circuit Breaker

Many applications will require that the inrush and steady state supply current be limited at a specific value in order to protect critical components within the system. Connecting a sense resistor between the VCC and SENSE pins sets the nominal current limit value of the MIC2582/83 and the current limit is calculated using Equation 2.

The MIC2582/83 also features a dual-level circuit breaker triggered via 50mV and 100mV current-limit thresholds sensed across the VCC and SENSE pins. The first level of the circuit breaker functions as follows. For the MIC2583/83R, once the voltage sensed across these two pins exceeds 50mV, the overcurrent timer, its duration set by capacitor  $C_{\text{FILTER}}$ , starts to ramp the voltage at  $C_{\text{FILTER}}$  using a  $6.5\mu\text{A}$  constant current source. If the voltage at  $C_{\text{FILTER}}$  reaches the overcurrent timer threshold ( $V_{\text{TH}}$ ) of 1.24V, then  $C_{\text{FILTER}}$  immediately returns to ground as the circuit breaker trips and the GATE output is immediately shut down. The default overcurrent time period for the MIC2582/83 is 5 $\mu\text{s}$ . For the second level, if the voltage sensed across VCC and SENSE exceeds 100mV at any time, the circuit breaker trips and the GATE shuts down immediately, bypassing the overcurrent time period. The MIC2582-MYM option is equipped with only a single circuit breaker threshold (50mV). To disable current limit and circuit breaker operation, tie the SENSE and VCC pins together and the  $C_{\text{FILTER}}$  (MIC2583/83R) pin to ground.

#### Output Undervoltage Detection

The MIC2582/83 employ output undervoltage detection by monitoring the output voltage through a resistive divider connected at the FB pin. During turn on, while the voltage at the FB pin is below the threshold ( $V_{\text{FB}}$ ), the /POR pin is asserted low.

Once the FB pin voltage crosses  $V_{\text{FB}}$ , a  $2.5\mu\text{A}$  current source charges capacitor  $C_{\text{POR}}$ . Once the CPOR pin voltage reaches 1.24V, the time period  $t_{\text{POR}}$  elapses as the CPOR pin is pulled to ground and the /POR pin goes HIGH. If the voltage at FB drops below  $V_{\text{FB}}$  for more than 10 $\mu\text{s}$ , the /POR pin resets for at least one timing cycle defined by  $t_{\text{POR}}$  (See Applications Information for an example).

#### Power-On Reset and Overcurrent Timer Delays

The Power-On Reset delay,  $t_{\text{POR}}$ , is the time period for the /POR pin to go HIGH once the voltage at the FB pin exceeds the power-good threshold ( $V_{\text{FB}}$ ). A capacitor connected to CPOR sets the interval and is determined by using Equation 1 with  $V_{\text{TH}}$  substituted for  $V_{\text{START}}$ . The resulting equation becomes:

$$t_{\text{POR}} = C_{\text{POR}} \times \frac{V_{\text{TH}}}{I_{\text{CPOR}}} \cong 0.5 \times C_{\text{POR}} (\mu\text{F}) \quad (7)$$

where the Power-On Reset threshold ( $V_{\text{TH}}$ ) and timer

current ( $I_{CPOR}$ ) are typically 1.24V and 2.5 $\mu$ A, respectively.

For the MIC2583/83R, a capacitor connected to CFILTER is used to set the timer which activates the circuit breaker during overcurrent conditions. When the voltage across the sense resistor exceeds the slow trip current limit threshold of 50mV, the overcurrent timer begins to charge for a time period ( $t_{OCSLOW}$ ), determined by  $C_{FILTER}$ . When no capacitor is connected to CFILTER and for the MIC2582,  $t_{OCSLOW}$  defaults to 5 $\mu$ s. If  $t_{OCSLOW}$  elapses, then the circuit breaker is activated and the GATE output is immediately pulled to ground. For the MIC2583/83R, the following equation is used to determine the overcurrent timer period,  $t_{OCSLOW}$ .

$$t_{OCSLOW} = C_{FILTER} \times \frac{V_{TH}}{I_{TIMER}} \cong 0.19 \times C_{FILTER} (\mu F) \quad (8)$$

where  $V_{TH}$ , the CFILTER timer threshold, is 1.24V and  $I_{TIMER}$ , the overcurrent timer current, is 6.5 $\mu$ A. Tables 2 and 3 provide a quick reference for several timer calculations using select standard value capacitors.

| $C_{POR}$     | $t_{START}$ | $t_{POR}$ |
|---------------|-------------|-----------|
| 0.01 $\mu$ F  | 1.2ms       | 5ms       |
| 0.02 $\mu$ F  | 2.4ms       | 10ms      |
| 0.033 $\mu$ F | 4ms         | 16.5ms    |
| 0.05 $\mu$ F  | 6ms         | 25ms      |
| 0.1 $\mu$ F   | 12ms        | 50ms      |
| 0.33 $\mu$ F  | 40ms        | 165ms     |
| 0.47 $\mu$ F  | 56ms        | 235ms     |
| 1 $\mu$ F     | 120ms       | 500ms     |

**Table 2. Selected Power-On Reset and Start-Up Delays**

| $C_{FILTER}$  | $t_{OCSLOW}$ |
|---------------|--------------|
| 680pF         | 130 $\mu$ s  |
| 2200pF        | 420 $\mu$ s  |
| 4700pF        | 900 $\mu$ s  |
| 8200pF        | 1.5ms        |
| 0.033 $\mu$ F | 6ms          |
| 0.1 $\mu$ F   | 19ms         |
| 0.22 $\mu$ F  | 42ms         |
| 0.47 $\mu$ F  | 90ms         |

**Table 3. Selected Overcurrent Timer Delays**

## Application Information

### Design Consideration for Output Undervoltage Detection

For output undervoltage detection, the first consideration is to establish the output voltage level that indicates “power is good.” For this example, the output value for which a 12V supply will signal “good” is 11V. Next, consider the tolerances of the input supply and FB threshold ( $V_{FB}$ ). For this example, the 12V supply varies  $\pm 5\%$ , thus the resulting output voltage may be as low as 11.4V and as high as 12.6V. Additionally, the FB threshold has  $\pm 50\text{mV}$  tolerance and may be as low as 1.19V and as high as 1.29V. Thus, to determine the values of the resistive divider network ( $R5$  and  $R6$ ) at the FB pin, shown in the typical application circuit on page 1, use the following iterative design procedure.

- 1) Choose  $R6$  to allow  $100\mu\text{A}$  or more in the FB resistive divider branch.

$$R6 = \frac{V_{FB(\text{MAX})}}{100\mu\text{A}} = \frac{1.29\text{V}}{100\mu\text{A}} = 12.9\text{k}\Omega$$

$R6$  is chosen as  $12.4\text{k}\Omega \pm 1\%$ .

- 2) Next, determine  $R5$  using the output “good” voltage of 11V and the following equation:

$$V_{OUT(\text{Good})} = V_{FB} \left[ \frac{(R5 + R6)}{R6} \right] \quad (9)$$

Using some basic algebra and simplifying Equation 9 to isolate  $R5$ , yields:

$$R5 = R6 \left[ \left( \frac{V_{OUT(\text{Good})}}{V_{FB(\text{MAX})}} \right) - 1 \right] \quad (9.1)$$

where  $V_{FB(\text{MAX})} = 1.29\text{V}$ ,  $V_{OUT(\text{Good})} = 11\text{V}$ , and  $R6$  is  $12.4\text{k}\Omega$ . Substituting these values into Equation 9.1 now yields  $R5 = 93.33\text{k}\Omega$ . A standard  $93.1\text{k}\Omega \pm 1\%$  is selected. Now, consider the 11.4V minimum output voltage, the lower tolerance for  $R6$  and higher tolerance for  $R5$ ,  $12.28\text{k}\Omega$  and  $94.03\text{k}\Omega$ , respectively. With only 11.4V available, the voltage sensed at the FB pin exceeds  $V_{FB(\text{MAX})}$ , thus the /POR and PWRGD (MIC2583/83R) signals will transition from LOW to HIGH, indicating “power is good” given the worse case tolerances of this example. Lastly, in giving consideration to the leakage current associated with the FB input, it is recommended to either: 1) provide ample design margin (20mV to 30mV) to allow for loss in the potential ( $\Delta V$ ) at the FB pin, or 2) allow  $\gg 100\mu\text{A}$  to flow in the FB resistor network.

### PCB Connection Sense

There are several configuration options for the MIC2582/83's ON pin to detect if the PCB has been fully seated in the backplane before initiating a start-up cycle. In the typical applications circuit, the MIC2582/83 is mounted on the PCB with a resistive divider network connected to the ON pin.  $R2$  is connected to a short pin on the PCB edge connector. Until the connectors mate, the ON pin is held low which keeps the GATE output charge pump off. Once the connectors mate, the resistor network is pulled up to the input supply, the ON pin is pulled up to the input supply,

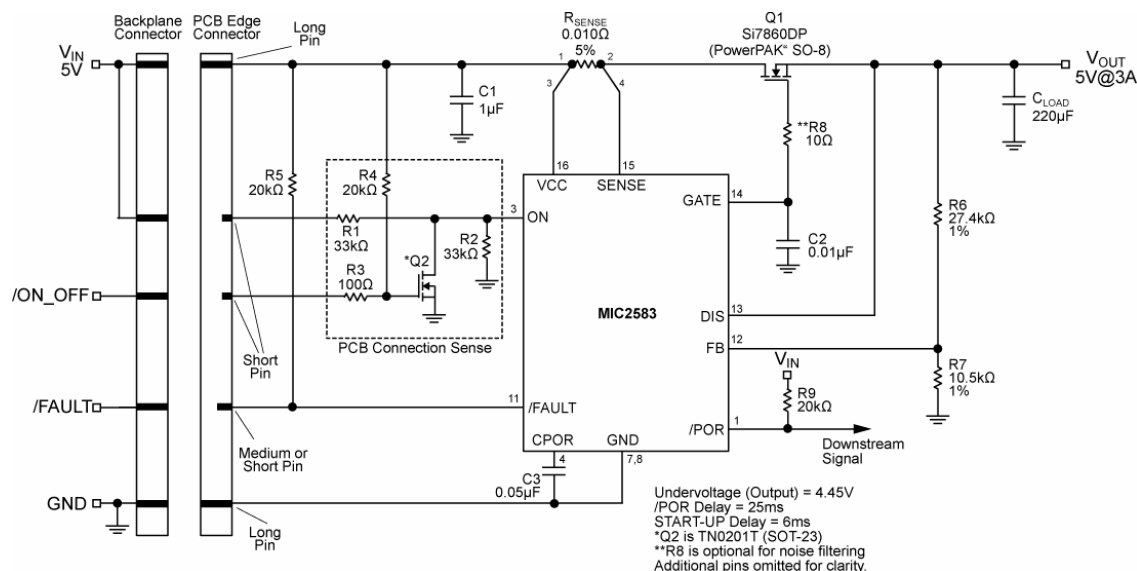


Figure 6. PCB Connection Sense with ON/OFF Control

12V in this example, and the ON pin voltage exceeds its threshold ( $V_{ON}$ ) of 1.24V and the MIC2582/83 initiates a start-up cycle. In Figure 6, the connection sense consisting of a discrete logic-level MOSFET and a few resistors allows for interrupt control from the processor or other signal controller to shut off the output of the MIC2582/83. R4 pulls the GATE of Q2 to  $V_{IN}$  and the ON pin is held low until the connectors are fully mated.

Once the connectors fully mate, a logic LOW at the /ON\_OFF signal turns Q2 off and allows the ON pin to pull up above its threshold and initiate a start-up cycle. Applying a logic HIGH at the /ON\_OFF signal will turn Q2 on and short the ON pin of the MIC2582/83 to ground which turns off the GATE output charge pump.

### Higher UVLO Setting

Once a PCB is inserted into a backplane (power supply), the internal UVLO circuit of the MIC2582/83 holds the GATE output charge pump off until VCC exceeds 2.2V. If VCC falls below 2.1V, the UVLO circuit pulls the GATE output to ground and clears the overvoltage and/or current limit faults. A typical 12V application, for example, should implement a higher UVLO than the internal 2.1V threshold of MIC2582 to avoid delivering power to downstream modules/loads while the input is below tolerance. For a higher UVLO threshold, the circuit in Figure 7 can be used to delay the output MOSFET from switching on until the desired input voltage is achieved. The circuit allows the charge pump to remain off

until  $V_{IN}$  exceeds  $\left(1 + \frac{R1}{R2}\right) \times 1.24V$ . The GATE drive output

will be shut down when  $V_{IN}$  falls below  $\left(1 + \frac{R1}{R2}\right) \times 1.19V$ . In

the example circuit (Figure 7), the rising UVLO threshold is set at approximately 9.5V and the falling UVLO threshold is established as 9.1V. The circuit consists of an external resistor divider at the ON pin that keeps the GATE output charge pump off until the voltage at the ON pin exceeds its threshold ( $V_{ON}$ ) and after the start-up timer elapses.

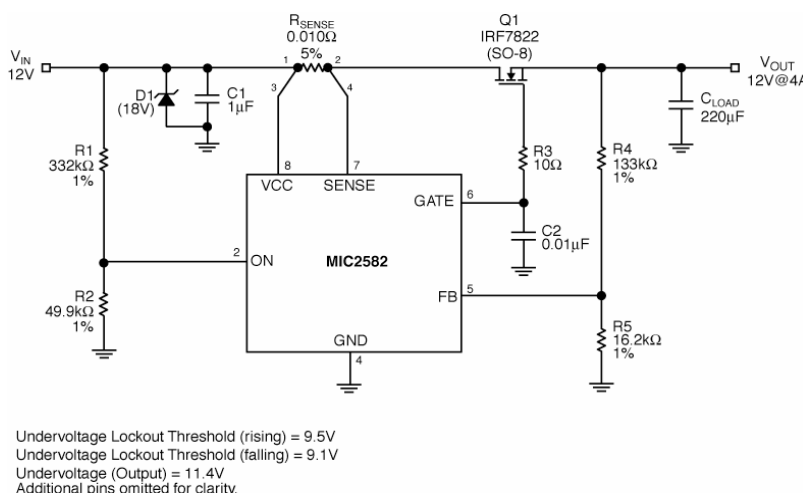


Figure 7. Higher UVLO Setting

### 5V Switch with 3.3V Supply Generation

The MIC2582/83 can be configured to switch a primary supply while generating a secondary regulated voltage rail. The circuit in Figure 8 enables the MIC2582 to switch a 5V supply while also providing a 3.3V low dropout regulated supply with only a few added external components. Upon enabling the MIC2582, the GATE output voltage increases and thus the 3.3V supply also begins to ramp. As the 3.3V output supply crosses 3.3V, the FB pin threshold is also exceeded which triggers the power-on reset comparator. The /POR pin goes HIGH, turning on transistor Q3 which lowers the voltage on the gate of MOSFET Q2. The result is a regulated 3.3V supply with the gate feedback loop of Q2 compensated by capacitor C3 and resistors R4 and R5. For MOSFET Q2, special consideration must be given to the power dissipation capability of the selected MOSFET as 1.5V to 2V will drop across the device during normal operation in this application. Therefore, the device is susceptible to overheating dependent upon the current requirements for the regulated output. In this example, the power dissipated by Q2 is approximately = 1W. However, a substantial amount of power will be generated with higher current requirements and/or conditions. As a general guideline, expect the ambient temperature within the power supply box to exceed the maximum operating ambient temperature of the system environment by approximately 20°C. Given the MOSFET's  $R_{\theta(JA)}$  and the expected power dissipated by the MOSFET, an approximation for the junction temperature at which the device will operate is obtained as follows:

$$T_J = (P_D \times R_{\theta(JA)}) + T_A \quad (10)$$

where  $T_A = T_{A \text{ (MAX OPERATING)}} + 20^\circ\text{C}$ . As a precaution, the implementation of additional copper heat sinking is highly recommended for the area under/around the MOSFET.

For additional information on MOSFET thermal considerations, please see MOSFET Selection text and subsequent sections.

## Auto-Restart - MIC2583R

The MIC2583R provides an auto-restart function. Upon an overcurrent fault condition such as a short circuit, the MIC2583R initially shuts off the GATE output. The MIC2583R attempts to restart with a 12 $\mu$ A charge current at a preset 10% duty cycle until the fault condition is removed. The interval between auto-retry attempts is set by capacitor C<sub>FILTER</sub>.

## Sense Resistor Selection

The MIC2582 and MIC2583 use a low-value sense resistor to measure the current flowing through the MOSFET switch (and therefore the load). This sense resistor is nominally set at  $50\text{mV}/I_{\text{LOAD(CONT)}}$ . To accommodate worst-case tolerances for both the sense resistor (allow  $\pm 3\%$  over time and temperature for a resistor with  $\pm 1\%$  initial tolerance) and still supply the maximum required steady-state load current, a slightly more detailed calculation must be used.

The current limit threshold voltage (i.e., the “trip point”) for the MIC2582/83 may be as low as 42mV, which would equate to a sense resistor value of  $42\text{mV}/I_{\text{LOAD(CONT)}}$ . Carrying the numbers through for the case where the value of the sense resistor is 3% high yields:

$$R_{SENSE(MAX)} = \frac{42mV}{(1.03)(I_{LOAD(CONT)})} = \frac{40.8mV}{I_{LOAD(CONT)}} \quad (11)$$

Once the value of  $R_{\text{SENSE}}$  has been chosen in this manner, it is good practice to check the maximum  $I_{\text{LOAD(CONT)}}$  which the circuit may let through in the case of tolerance buildup in the opposite direction. Here, the worst-case maximum current is found using a 59mV trip voltage and a sense resistor that is 3% low in value. The resulting equation is:

$$I_{LOAD(CONT,MAX)} = \frac{59mV}{(0.97)(R_{SENSE(NOM)})} = \frac{60.8mV}{R_{SENSE(NOM)}} \quad (12)$$

As an example, if an output must carry a continuous 2A without nuisance trips occurring, Equation 11

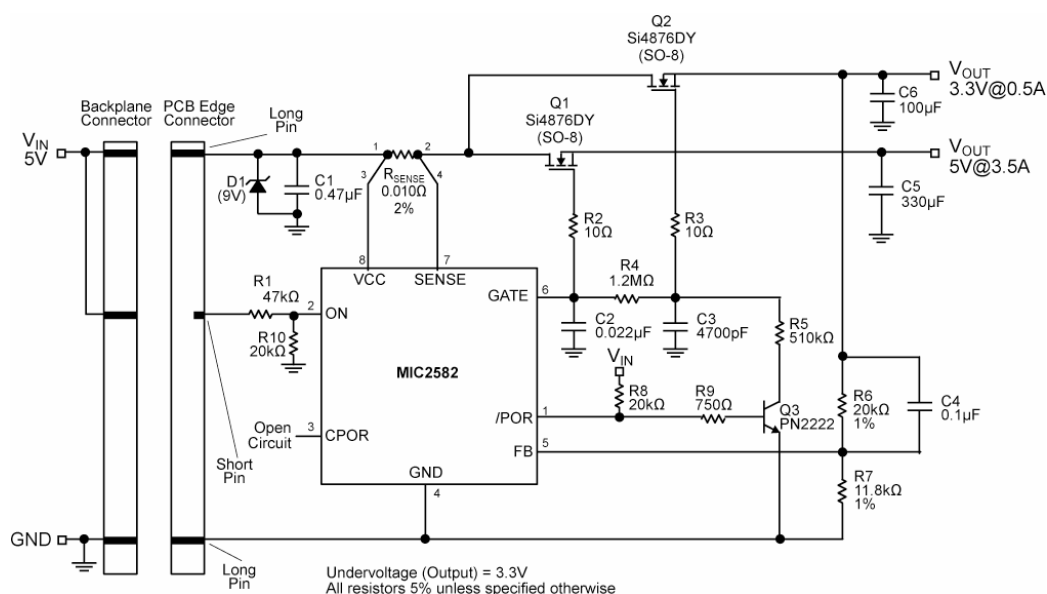
yields:  $R_{SENSE(MAX)} = \frac{40.8mV}{2A} = 20.4m\Omega$ . The next

lowest standard value is 20mΩ. At the other set of tolerance extremes for the output in question,

$$I_{LOAD(CONT,MAX)} = \frac{60.8mV}{20.0m\Omega} = 3.04A, \text{ approximately } 3A.$$

Knowing this final data, we can determine the necessary wattage of the sense resistor using  $P = I^2 R$ , where  $I$  will be  $I_{LOAD(CONT, MAX)}$ , and  $R$  will be  $(0.97)(R_{SENSE(NOM)})$ . These numbers yield the following:  $P_{MAX} = (3A)^2 (19.4m\Omega) = 0.175W$ .

In this example, a  $\frac{1}{4}W$  sense resistor is sufficient.



### Figure 8. 5V Switch/3.3V LDO Application

## MOSFET Selection

Selecting the proper external MOSFET for use with the MIC2582/83 involves three straightforward tasks:

- Choice of a MOSFET which meets minimum voltage requirements.
- Selection of a device to handle the maximum continuous current (steady-state thermal issues).
- Verify the selected part's ability to withstand any peak currents (transient thermal issues).

## MOSFET Voltage Requirements

The first voltage requirement for the MOSFET is easily stated: the drain-source breakdown voltage of the MOSFET must be greater than  $V_{IN(MAX)}$ . For instance, a 12V input may reasonably be expected to see high-frequency transients as high as 18V. Therefore, the drain-source breakdown voltage of the MOSFET must be at least 19V. For ample safety margin and standard availability, the closest value will be 20V.

The second breakdown voltage criterion that must be met is a bit subtler than simple drain-source breakdown voltage, but is not hard to meet. In MIC2582/83 applications, the gate of the external MOSFET is driven up to approximately 19.5V by the internal output

MOSFET (again, assuming 12V operation).

At the same time, if the output of the external MOSFET (its source) is suddenly subjected to a short, the gate-source voltage will go to  $(19.5V - 0V) = 19.5V$ . This means that the external MOSFET must be chosen to have a gate-source breakdown voltage of 20V or more, which is an available standard maximum value. However, if operation is at or above 13V, the 20V gate-source maximum will likely be exceeded. As a result, an external Zener diode clamp should be used to prevent breakdown of the external MOSFET when operating at voltages above 8V. A Zener diode with 10V rating is recommended as shown in Figure 9. At the present time, most power MOSFETs with a 20V gate-source voltage rating have a 30V drain-source breakdown rating or higher.

As a general tip, choose surface-mount devices with a drain-source rating of 30V as a starting point.

Finally, the external gate drive of the MIC2582/83 requires a low-voltage logic level MOSFET when operating at voltages lower than 3V. There are 2.5V logic level MOSFETs available. Please see Table 4 "MOSFET and Sense Resistor Vendors" for suggested manufacturers.

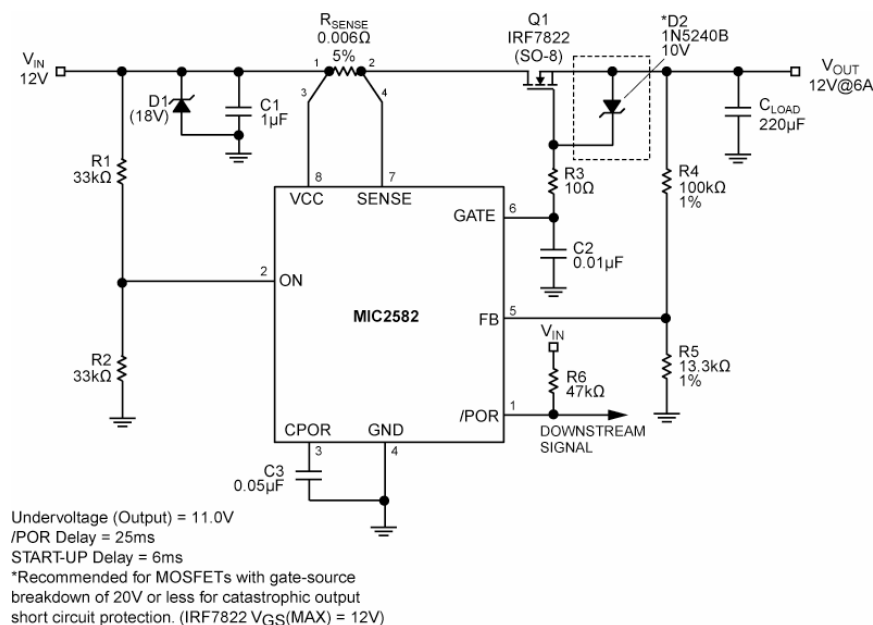


Figure 9. Zener Clamped MOSFET Gate

## MOSFET Steady-State Thermal Issues

The selection of a MOSFET to meet the maximum continuous current is a fairly straightforward exercise. First, arm yourself with the following data:

- The value of  $I_{\text{LOAD(CONT. MAX.)}}$  for the output in question (see Sense Resistor Selection).
- The manufacturer's data sheet for the candidate MOSFET.
- The maximum ambient temperature in which the device will be required to operate.
- Any knowledge you can get about the heat sinking available to the device (e.g., can heat be dissipated into the ground plane or power plane, if using a surface-mount part? Is any airflow available?).

The data sheet will almost always give a value of on-resistance given for the MOSFET at a gate-source voltage of 4.5V, and another value at a gate-source voltage of 10V. As a first approximation, add the two values together and divide by two to get the on-resistance of the part with 8V of enhancement.

Call this value  $R_{\text{ON}}$ . Since a heavily enhanced MOSFET acts as an ohmic (resistive) device, almost all that's required to determine steady-state power dissipation is to calculate  $I^2R$ .

The one addendum to this is that MOSFETs have a slight increase in  $R_{\text{ON}}$  with increasing die temperature. A good approximation for this value is 0.5% increase in  $R_{\text{ON}}$  per °C rise in junction temperature above the point at which  $R_{\text{ON}}$  was initially specified by the manufacturer. For instance, if the selected MOSFET has a calculated  $R_{\text{ON}}$  of 10mΩ at a  $T_J = 25^\circ\text{C}$ , and the actual junction temperature ends up at 110°C, a good first cut at the operating value for  $R_{\text{ON}}$  would be:

$$R_{\text{ON}} \cong 10\text{m}\Omega [1 + (110 - 25)(0.005)] \cong 14.3\text{m}\Omega \quad (13)$$

The final step is to make sure that the heat sinking available to the MOSFET is capable of dissipating at least as much power (rated in °C/W) as that with which the MOSFETs performance was specified by the manufacturer. Here are a few practical tips:

1. The heat from a surface-mount device such as an SOIC-8 MOSFET flows almost entirely out of the drain leads. If the drain leads can be soldered down to one square inch or more, the copper will act as the heat sink for the part. This copper must be on the same layer of the board as the MOSFET drain.
2. Airflow works. Even a few LFM (linear feet per minute) of air will cool a MOSFET down substantially.

If you can, position the MOSFET(s) near the inlet of a power supply's fan, or the outlet of a

processor's cooling fan.

3. The best test of a surface-mount MOSFET for an application (assuming the above tips show it to be a likely fit) is an empirical one. Check the MOSFETs temperature in the actual layout of the expected final circuit, at full operating current. The use of a thermocouple on the drain leads, or infrared pyrometer on the package, will then give a reasonable idea of the device's junction temperature.

## MOSFET Transient Thermal Issues

Having chosen a MOSFET that will withstand the imposed voltage stresses, and the worse case continuous  $I^2R$  power dissipation which it will see, it remains only to verify the MOSFETs ability to handle short-term overload power dissipation without overheating. A MOSFET can handle a much higher pulsed power without damage than its continuous dissipation ratings would imply. The reason for this is that, like everything else, thermal devices (silicon die, lead frames, etc.) have thermal inertia.

In terms related directly to the specification and use of power MOSFETs, this is known as "transient thermal impedance," or  $Z_{\theta(\text{JA})}$ . Almost all power MOSFET data sheets give a Transient Thermal Impedance Curve. For example, take the following case:  $V_{\text{IN}} = 12\text{V}$ ,  $t_{\text{OCSLOW}}$  has been set to 100msec,  $I_{\text{LOAD(CONT. MAX.)}}$  is 2.5A, the slow-trip threshold is 50mV nominal, and the fast-trip threshold is 100mV. If the output is accidentally connected to a 3Ω load, the output current from the MOSFET will be regulated to 2.5A for 100ms ( $t_{\text{OCSLOW}}$ ) before the part trips. During that time, the dissipation in the MOSFET is given by:

$$P = E \times I; E_{\text{MOSFET}} = [12\text{V} - (2.5\text{A})(3\Omega)] = 4.5\text{V}$$

$$P_{\text{MOSFET}} = (4.5\text{V} \times 2.5\text{A}) = 11.25\text{W for 100msec.}$$

At first glance, it would appear that a really hefty MOSFET is required to withstand this sort of fault condition. This is where the transient thermal impedance curves become very useful. Figure 10 shows the curve for the Vishay (Siliconix) Si4410DY, a commonly used SOIC-8 power MOSFET.

Taking the simplest case first, we'll assume that once a fault event such as the one in question occurs, it will be a long time— 10 minutes or more— before the fault is isolated and the channel is reset. In such a case, we can approximate this as a "single pulse" event, that is to say, there's no significant duty cycle. Then, reading up from the X-axis at the point where "Square Wave Pulse Duration" is equal to 0.1sec (=100msec), we see that the  $Z_{\theta(\text{JA})}$  of this MOSFET to a highly infrequent event of this duration is only 8% of its continuous  $R_{\theta(\text{JA})}$ .

This particular part is specified as having an  $R_{\theta(\text{JA})}$  of 50°C/W for intervals of 10 seconds or less.

Thus:

Assume  $T_A = 55^\circ\text{C}$  maximum, 1 square inch of copper at the drain leads, no airflow.

Recalling from our previous approximation hint, the part has an  $R_{ON}$  of  $(0.0335/2) = 17\text{m}\Omega$  at  $25^\circ\text{C}$ .

Assume it has been carrying just about 2.5A for some time.

When performing this calculation, be sure to use the highest anticipated ambient temperature ( $T_{A(\text{MAX})}$ ) in which the MOSFET will be operating as the starting temperature, and find the operating junction temperature increase ( $\Delta T_J$ ) from that point. Then, as shown next, the final junction temperature is found by adding  $T_{A(\text{MAX})}$  and  $\Delta T_J$ . Since this is not a closed-form equation, getting a close approximation may take one or two iterations, and the calculation tends to converge quickly.

Then the starting (steady-state)  $T_J$  is:

$$\begin{aligned} T_J &\cong T_{A(\text{MAX})} + \Delta T_J \\ &\cong T_{A(\text{MAX})} + [R_{ON} + T_{A(\text{MAX})} - T_A](0.005/^\circ\text{C})(R_{ON}) \\ &\quad \times I^2 \times R_{\theta(\text{JA})} \\ T_J &\cong 55^\circ\text{C} + [17\text{m}\Omega + (55^\circ\text{C} - 25^\circ\text{C})(0.005)(17\text{m}\Omega)] \end{aligned}$$

$$\times (2.5\text{A})^2 \times (50^\circ\text{C}/\text{W})$$

$$\begin{aligned} T_J &\cong (55^\circ\text{C} + (0.122\text{W})(50^\circ\text{C}/\text{W})) \\ &\cong 61.1^\circ\text{C} \end{aligned}$$

Iterate the calculation once to see if this value is within a few percent of the expected final value. For this iteration we will start with  $T_J$  equal to the already calculated value of  $61.1^\circ\text{C}$ :

$$\begin{aligned} T_J &\cong T_A + [17\text{m}\Omega + (61.1^\circ\text{C} - 25^\circ\text{C})(0.005)(17\text{m}\Omega)] \\ &\quad \times (2.5\text{A})^2 \times (50^\circ\text{C}/\text{W}) \end{aligned}$$

$$T_J \cong (55^\circ\text{C} + (0.125\text{W})(50^\circ\text{C}/\text{W})) \cong 61.27^\circ\text{C}$$

So our original approximation of  $61.1^\circ\text{C}$  was very close to the correct value. We will use  $T_J = 61^\circ\text{C}$ .

Finally, add the temperature increase due to the maximum power dissipation calculated from a "single event",  $(11.25\text{W})(50^\circ\text{C}/\text{W})(0.08) = 45^\circ\text{C}$  to the steady-state  $T_J$  to get  $T_{J(\text{TRANSIENT MAX.})} = 106^\circ\text{C}$ . This is an acceptable maximum junction temperature for this part.

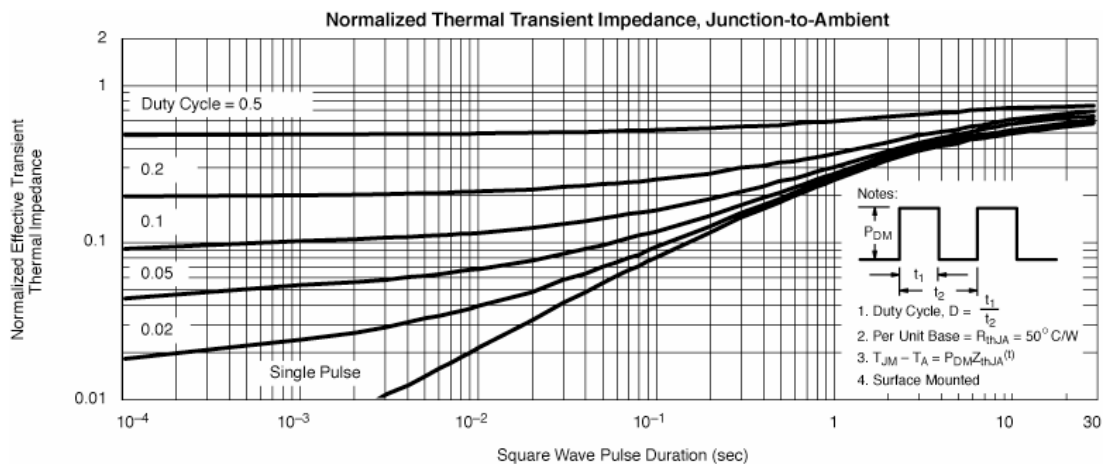


Figure 10. Transient Thermal Impedance

## PCB Layout Considerations

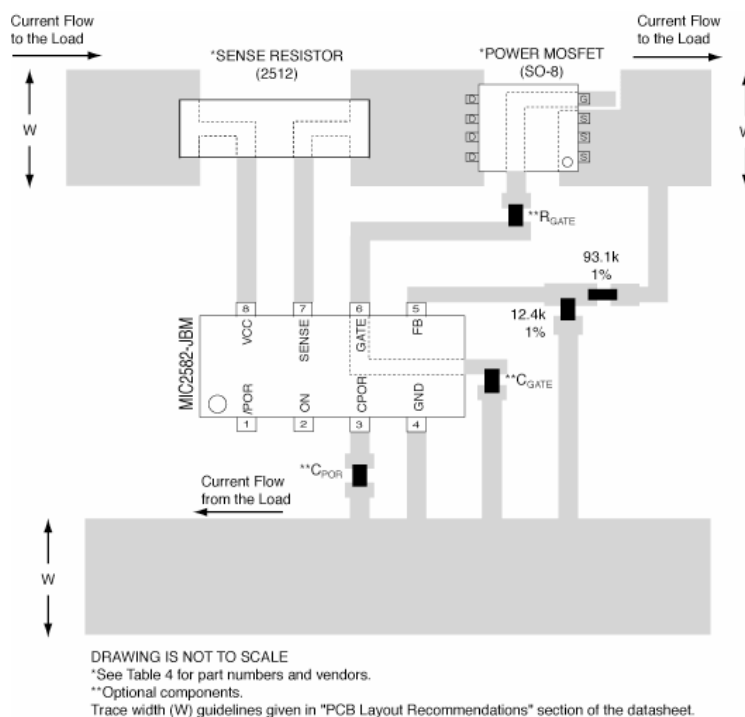
Because of the low values of the sense resistors used with the MIC2582/83 controllers, special attention to the layout must be used in order for the device's circuit breaker function to operate properly. Specifically, the use of a 4-wire Kelvin connection to accurately measure the voltage across  $R_{SENSE}$  is highly recommended. Kelvin sensing is simply a means of making sure that any voltage drops in the power traces connecting to the resistors does not get picked up by the traces themselves. Additionally, these Kelvin connections should be isolated from all other signal traces to avoid introducing noise onto these sensitive nodes. Figure 11 illustrates a recommended, single layer layout for the  $R_{SENSE}$ , Power MOSFET, timer(s), and feedback network connections. The feedback network resistor values are selected for a 12V application. Many hot swap applications will require load currents of several amperes. Therefore, the power ( $V_{CC}$  and Return) trace

widths (W) need to be wide enough to allow the current to flow while the rise in temperature for a given copper plate (e.g., 1oz. or 2oz.) is kept to a maximum of 10°C~25°C. Also, these traces should be as short as possible in order to minimize the IR drops between the input and the load.

Finally, the use of plated-through vias will be needed to make circuit connections to power and ground planes when utilizing multi-layer PC boards.

## MOSFET and Sense Resistor Vendors

Device types and manufacturer contact information for power MOSFETs and sense resistors are provided in Table 4. Some of the recommended MOSFETs include a metal heat sink on the bottom side of the package. The recommended trace for the MOSFET Gate of Figure 11 must be redirected when using MOSFETs packaged in this style. Contact the device manufacturer for package information.



**Figure 11. Recommended PCB Layout for Sense Resistor, Power MOSFET, and Feedback Network**

| MOSFET Vendor           | Key MOSFET Type(s)                                                                                                 | Applications <sup>(1)</sup>                                                                                      | Contact Information                      |
|-------------------------|--------------------------------------------------------------------------------------------------------------------|------------------------------------------------------------------------------------------------------------------|------------------------------------------|
| Vishay (Siliconix)      | Si4420DY (SOIC-8) package<br>Si4442DY (SOIC-8) package<br>Si4876DY (SOIC-8) package<br>Si7892DY (PowerPAK™ SOIC-8) | $I_{OUT} \leq 10A$<br>$I_{OUT} = 10-15A, V_{CC} < 3V$<br>$I_{OUT} \leq 5A, V_{CC} \leq 5V$<br>$I_{OUT} \leq 15A$ | www.siliconix.com<br>(203) 452-5664      |
| International Rectifier | IRF7413 (SOIC-8 package)<br>IRF7457 (SOIC-8 package)<br>IRF7601 (SOIC-8 package)                                   | $I_{OUT} \leq 10A$<br>$I_{OUT} = 10-15A$<br>$I_{OUT} \leq 5A, V_{CC} \leq 3V$                                    | www.irf.com<br>(310) 322-3331            |
| Fairchild Semiconductor | FDS6680A (SOIC-8 package)                                                                                          | $I_{OUT} \leq 10A$                                                                                               | www.fairchildsemi.com<br>(207) 775-8100  |
| Philips                 | PH3230 (SOT669-LFPAK)                                                                                              | $I_{OUT} \geq 20A$                                                                                               | www.philips.com                          |
| Hitachi                 | HAT2099H (LFPAK)                                                                                                   | $I_{OUT} \geq 20A$                                                                                               | www.halisp.hitachi.com<br>(408) 433-1990 |

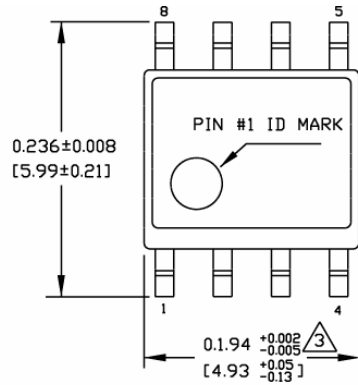
**Note:**

1. These devices are not limited to these conditions in many cases, but these conditions are provided as a helpful reference for customer applications.

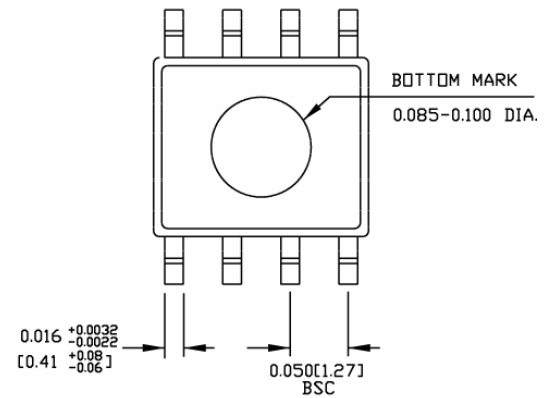
| Resistor Vendors | Sense Resistors                                          | Contact Information                                                                   |
|------------------|----------------------------------------------------------|---------------------------------------------------------------------------------------|
| Vishay (Dale)    | "WSL" Series                                             | www.vishay.com/docswsl_30100.pdf<br>(203) 452-5664                                    |
| IRC              | "OARS" Series<br>"LR" Series<br>(second source to "WSL") | www.irctt.com/pdf_files/OARS.pdf<br>www.irctt.com/pdf_files/LRC.pdf<br>(828) 264-8861 |

**Table 4. MOSFET and Sense Resistor Vendors**

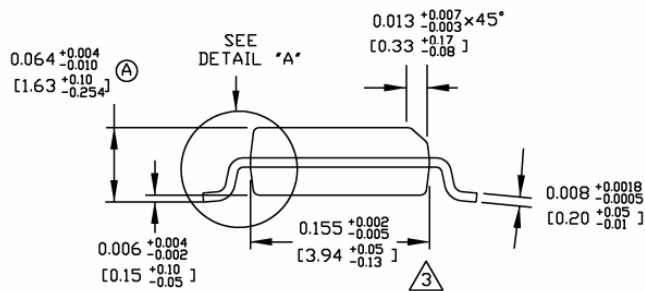
## Package Information



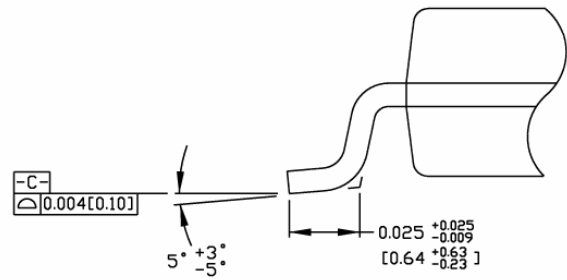
TOP VIEW



BOTTOM VIEW



END VIEW

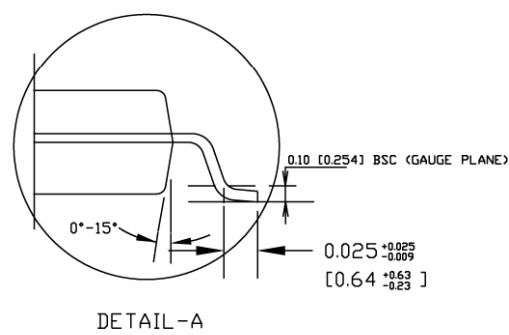
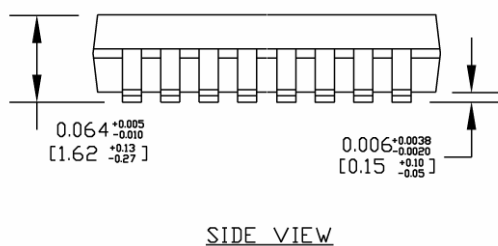
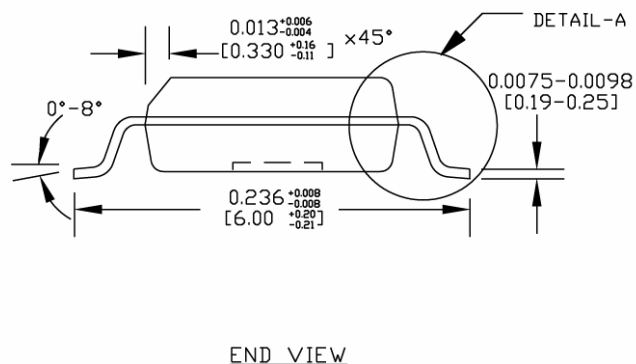
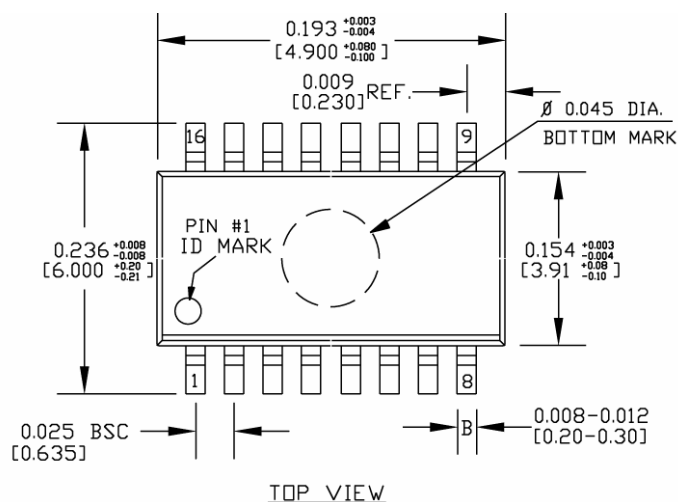


DETAIL "A"

### NOTES:

1. DIMENSIONS ARE IN INCHES[MM].
2. CONTROLLING DIMENSION: INCHES.
3. DIMENSION DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, EITHER OF WHICH SHALL NOT EXCEED 0.010[0.25] PER SIDE.

### 8-Pin SOIC (M)



## NOTE:

1. ALL DIMENSIONS ARE IN INCHES [MM].
2. LEAD COPLANARITY SHOULD BE 0.004" [0.10 mm] MAX.
3. MAX MISALIGNMENT BETWEEN TOP AND BOTTOM CENTER OF PACKAGE TO BE 0.004" [0.10 mm].
4. THE LEAD WIDTH, B TO BE DETERMINED AT .0075 [0.19 mm] FROM THE LEAD TIP.
5. BOTTOM MARK IS OPTIONAL, IT MAY NOT APPEAR ON THE ACTUAL UNITS.

## 16-Pin QSOP (QS)

**MICREL, INC. 2180 FORTUNE DRIVE SAN JOSE, CA 95131 USA**

TEL +1 (408) 944-0800 FAX +1 (408) 474-1000 WEB <http://www.micrel.com>

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- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

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кабельные сборки и микроволновые компоненты:

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